HM4864-2, HM4864-3 HM4864P-2, HM4864P-3

65536-word × 1-bit Dynamic Random Access Memory

The HM4864 is a 65,536-words by 1-bit, MOS random access memory circuit fabricated with HITACHI's double-poly N-channel silicon gate process for high performance and high functional density. The HM4864 uses a single transistor dynamic storage cell and dynamic control circuitry to achieve high speed and low power dissipation.

Multiplexed address inputs permit the HM4864 to be packaged in a standard 16 pin DIP on 0.3 inch centers.

This package size provides high system bit densities and is compatible with widely available automated testing and insertion equipment. System oriented features include single power supply of $\pm 5V$ with $\pm 10\%$ tolerance, direct interfacing capability with high performance logic families such as Schottky TTL, maximum input noise immunity to minimize "false triggering" of the inputs, on-chip address and data registers which eliminate the need for interface registers, and two chip select methods to allow the user to determine the appropriate speed/power characteristics of this memory system. The HM4864 also incorporates several flexible timing/operating modes.

In addition to the usual read,write, and read-modify-write cycles, the HM4864 is capable of delayed write cycles, page-mode operation and \overline{RAS} -only refresh.

Proper control of the clock inputs (\overline{RAS} , \overline{CAS} , and \overline{WE}) allows common I/O capability, two dimensional chip selection, and extended page boundaries (when operating in page mode).

FEATURES

- Recognized industry standard 16-pin configuration
- 150ns access time, 270ns cycle time (HM4864-2, HM4864P-2)
- 200ns access time, 335ns cycle time (HM4864-3, HM4864P-3)
- Single power supply of $+5V\pm10\%$ with a built-in V_{BB} generator
- Low Power; 330 mW active. 20 mW standby (max)
- The inputs TTL compatible, low capacitance, and protected against static charge
- Output data controlled by CAS and unlatched at end of cycle to allow two dimensional chip selection and extended page boundary
- · Common I/O capability using "early write" operation
- Read-Modify-Write, RAS-only refresh, and Page-mode capability
- 128 refresh cycle



PIN ARRANGEMENT



(Top View)

A A ?	Address Inputs
CAS	Column Address Strobe
Din	Data In
Dout	Data Out
RAS	Row Address Strobe
WE	Read/Write Input
Vcc	Power (+5V)
Vss	Ground
A A .	Refresh Address Input



FUNCTIONAL BLOCK DIAGRAM



RECOMMENDED DC OPERATING CONDITIONS (Ta=0 to +70°C)

Parameter	Symbol	min	typ	max	Unit	Notes	
Supply Voltage	Vcc	4.5	5.0	5.5	v		
	Vss	0	0	0	v	1	
Input High Voltage	Vin	2.4	-	€.5	v	1	
Input Low Voltage	VIL	-1.0		0.8	v	1	

DC ELECTRICAL CHARACTERISTICS (Ta=0 to $+70^{\circ}$ C, $V_{cc}=5V\pm10\%$, $V_{ss}=0V$)

Parameter	Symbol	min	max	Unit	Notes
OPERATING CURRENT Average Power Supply Operating Current ($\overline{RAS}, \overline{CAS}$ Cycling; $t_{BC} = \min$.)	Icci		60	m A	2,4
STANDBY CURRENT Power Supply Standby Current ($\overline{RAS} = V_{116}$ Dout – High Impedance)	Icc 2	_	3.5	m A	2
REFRESH CURRENT Average Power Supply Current, Refresh Mode (RAS Cycling, CAS = Vin; t Rc = min.)	Icc 3		45	mA	2, 4
PAGE MODE CURRENT Average Power Supply Current, Page-mode Operation (RAS = V(L CAS Cycling; tpc=min.)	Icc.	_	45	mA	2,4
INPUT LEAKAGE Input Leakage Current, any Input $(V_{**}=0 \text{ to } +6.5V, \text{ all other pins not} under test=0V)$	Lu	-10	10	μA	
OUTPUT LEAKAGE Output Leakage Current (Dout is disabled, $V_{sut} = 0$ to ± 5.5 V)	ILO	-10	10	μA	3
OUTPUT LEVELS Output High (Logic 1) Voltage (Inv = -5mA) Output Low (Logic 0) Voltage (Inv = 4.2mA)	Vон Vot	2.4 0	V _{ec} 0.4	v v	

NOTES

1. All voltages referenced to V_{SS} .

2. I_{CC} depends on output loading condition when the device is selected. I_{CC} max. is specified at the output open condition.

3. I_{LO} consists of leakage current only.

4. Current depends on cycle rate: maximum current is measured at the fastest cycle rate.

AC ELECTRICAL CHARACTERISTICS

Parameter	Symbol	typ	max	Unit	Notes
Input Capacitance (Ao-Ar, Din)	C1	_	7	pF	1
Input Capacitance (RAS, CAS, WE)	C., 2		10	pF	1
Output Capacitance (Dout)	Court		7	pF	1, 2

NOTES

1. Capacitance measured with Boonton Meter or effective capacitance measuring method.

2. $\overline{CAS} = V_{IH}$ to disable D_{OUT}



D	Symbol	HM 4864-2/P-2		HM 4864-3/P-3		Unit	Notes
Parameter		min	max	min	max	Unit	Notes
Random Read or Write Cycle Time	t _{RC}	270	-	335		ns	
Read-Write Cycle Time	t _{RWC}	270		335		ns	
Page Mode Cycle Time	t _{PC}	170		225	-	ns	
Access Time from RAS	tRAC	-	150	_	200	ns	4,6
Access Time from CAS	t _{CAC}	-	100	_	135	ns	5,6
Output Buffer Turn-off Delay	toFF	0	40	0	50	ns	7
Transition Time (Rise and Fall)	tT	3	35	3	50	ns	3
RAS Precharge Time	1 _{RP}	100	_	120		ns	
RAS Pulse Width	I RAS	150	10000	200	10000	ns	
RAS Hold Time	t _{RSH}	100	-	135		ns	
CAS Pulse Width	tCAS	100		135	-	ns	
CAS Hold Time	t _{csH}	150	-	200	-	ns	
RAS to CAS Delay Time	tRCD	20	50	25	65	ns	8
CAS to RAS Precharge Time	t _{CRP}	-20	_	- 20	-	ns	
Row Address Set-up Time	LASR	0	-	0	-	ns	
Row Address Hold Time	t RAH	20	_	25	-	ns	
Column Address Set-up Time	tASC	-10		-10	-	ns	
Column Address Hold Time	t _{CAH}	45		55	- 1	ns	
Column Address Hold Time referenced to RAS	t _{AR}	95		120	- 1	ns	
Read Command Set-up Time	tres	0	-	0		ns	
Read Command Hold Time	t _{RCH}	0		0	-	ns	
Write Command Hold Time	twch	45		55	-	ns	
Write Command Hold Time referenced to RAS	twck	95		120		ns	
Write Command Pulse Width	twp	45	-	55	-	ns	
Write Command to RAS Lead Time	t _{RWL}	45		55		ns	
Write Command to CAS Lead Time	tcwL	45	-	55	-	ns	
Data-in Set-up Time	t _{DS}	0	-	0	-	ns	9
Data-in Hold Time	t _{DH}	45	-	55	-	ns	9
Data-in Hold Time referenced to RAS	t _{DHR}	95	-	120	-	ns	
CAS Precharge Time (for Page-mode Cycle Only)	tcr	60	_	80		ns	
Refresh Period	tREF		2		2	ms	
Write Command Set-up Time	twcs	-20	-	- 20	-	ns	10
\overline{CAS} to \overline{WE} Delay	tcwp	60	-	80	-	ns	10
RAS to WE Delay	t _{RWD}	110	-	145	-	ns	10
RAS Precharge to CAS Hold Time	1 RPC	0	-	0	- 1	ns	

ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS ^{1), 2)} $(T_{a=0} t_{0} + 70^{\circ}C, V_{cc} = 5V \pm 10\%, V_{ss} = 0V)$

NOTES

- 1. AC measurements assume $t_T = 5$ ns.
- 8 cycles are required after power-on or prolonged periods (greater than 2ms) of RAS inactivity before proper device operation is achieved. Any 8 cycles which perform refresh are adequate for this purpose.
- 3. V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} and V_{IL} .
- 4. Assumes that $t_{RCD} \leq t_{RCD}$ (max). If t_{RCD} is greater than the maximum recommended value shown in this table t_{RAC} exceeds the value shown.
- 5. Assumes that $t_{RCD} \ge t_{RCD}$ (max).
- Measured with a load circuit equivalent to 2TTL loads and 100 pF.
- t_{OFF} (max) defines the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
- 8. Operation with the t_{RCD} (max) limit insures that

 t_{RAC} (max) can be met. t_{RCD} (max) is specified as a reference point only; if t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively be t_{CAC} .

- These parameters are reference to CAS leading edge in early write cycles and to WE leading edge in delayed write or read-modify-write cycles.
- 10. t_{WCS} , t_{CWD} and t_{RWD} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only: if $t_{WCS} \ge t_{WCS}$ (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{CWD} \ge t_{CWD}$ (min) and $t_{RWD} \ge$ t_{RWD} (min) the cycle is a read/write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied the condition of the data out (at access time) is indeterminate.



TIMING WAVEFORMS

• READ CYCLE



WRITE CYCLE



•READ-WRITE/READ-MODIFY-WRITE CYCLE



•"RAS-ONLY" REFRESH CYCLE



•PAGE MODE READ CYCLE



• PAGE MODE WRITE CYCLE



TYPICAL CHARACTERISTICS



SUPPLY CURRENT vs. SUPPLY VOLTAGE



SUPPLY CURRENT







SUPPLY CURRENT vs. AMBIENT TEMPERATURE



SUPPLY CURRENT vs. SUPPLY VOLTAGE







SUPPLY CURRENT vs. AMBIENT TEMPERATURE



SUPPLY CURRENT vs. SUPPLY VOLTAGE



SUPPLY CURRENT



SUPPLY CURRENT V3. AMBIENT TEMPERATURE







INPUT LEVEL vs. Ambient temperature



CLOCK INPUT LEVEL vs. SUPPLY VOLTAGE



 vs. AMBIENT TEMPERATURE

 2.5
 V(c = 5.0V)

CLOCK INPUT LEVEL







APPLICATION INFORMATION

POWER ON

An initial pause of 500 μ s is required after power-up and a minimum of eight (8) initialization cycle, (any combination of cycles containing a RAS clock such as RAS-only refresh) must follow an initial pause.

The V_{CC} current (I_{CC}) requirement of the HM4864 during power on is, however, dependent upon the input levels (RAS, CAS) and the rise time of V_{CC} , as shown in Fig. 1.

• READ CYCLE

A read cycle begins with addresses stable and a negative going transition of \overline{RAS} . The time delay between the stable address and the start of \overline{RAS} -on is controlled by parameter t_{ASR} .

Following the time when \overline{RAS} reaches its low level, the row address must be held stable long enough to be captured. This controlling parameter is t_{RAH} . Following this interval, the address can be changed from row address to column address. When the column address is stable, \overline{CAS} can be turned on. The leading edge of \overline{CAS} is controlled by parameter t_{RCD} . The basic limit on the \overline{CAS} leading edge is that \overline{CAS} can not start until the column address is stable, and this is controlled by parameter t_{ASC} . The column address must be held stable long enough to be captured. The controlling parameter is t_{CAH} . Note that t_{RCD} (max) is not an operating limit of the HM4864 though its specification is listed on the data sheets. If \overline{CAS} becomes on later than t_{RCD} (max), the access time from \overline{RAS} will be increased by the time which t_{RCD} exceeds t_{RCD} (max).

Following the time when \overline{CAS} reaches its low level, the data-out pin remains in a high impedance state until a valid data appears. This parameter is t_{CAC} -access time from \overline{CAS} .

The access time from \overline{RAS} - t_{RAC} -is the time from \overline{RAS} -on to valid Dout.

The minimum value of t_{RAC} is derived as the sum of t_{RCD} (max) and t_{CAC} .

The selected output data is held valid internally until \overline{CAS} becomes high, and then Dout pin becomes high impedance. This parameter is *toff*.



Fig.1 Icc vs. Vcc during power up.



WRITE CYCLE

A write cycle is performed by bringing \overline{WE} low before or during \overline{CAS} -on.

Two different write cycles can be defined as;

Write cycle-Write data are available at the beginning of the CAS-on so that the write operation starts at the beginning. In this mode, Dout and \overline{WE} signal times are not in any critical path for determining cycle time.

Following the time when \overline{WE} reaches its low level, \overline{WE} must be held stable long enough to be captured. This \overline{WE} -on pulse deration is called t_{WP} . The time required to capture write data in a latch is called t_{DH} . This cycle is called an "early write".

Read Write cycle—This cycle starts as a read cycle, but as soon as the device specification is met, a write cycle is initiated.

WE and Din are delayed until after Dout. This cycle is called a "delayed write". A "Read-modify-write" cycle is a variation of this operation. In this mode, Din and WE become critical path signals for determining cycle time.

CLOCK-OFF TIMING

RAS and CAS must stay on for Dout stabilized to valid data. In the case of CAS, this is controlled by parameter t_{CAS} (min).

In the case of \overline{RAS} , this is controlled by parameter t_{CAS} (min). Following the end of \overline{RAS} , \overline{CAS} must stay off long enough to precharge internal circuits. The only parameter of concern is t_{RP} . Normally \overline{CAS} is not required to be off for minimum time of t_{CRP} . However, in a page mode memory operation, there is a t_{CP} (min) specification to control the \overline{CAS} -off time.

DATA OUTPUT

Dout is three-state TTL compatible with a fan-out of two standard TTL loads.

When \overrightarrow{CAS} is high, Dout is in a high impedance state. When \overrightarrow{CAS} is low, valid data appears after t_{CAC} at a read cycle, and Dout is not valid as an early-write cycle.

REFRESH

Refresh of the HM4864 is accomplished by performing a memory cycle at each of the 128 row addresses within each two millisecond time interval. A0 to A6 are refresh address pin compatible with standard 16K RAM (HM4716A, HM4816A). During refresh, either V_{1L} or V_{1H} is permitted for A7. Any cycle in which RAS signal occurs refreshes the entire selected row. RAS-only refresh results in substantial reduction in operating power. This reduction in power is reflected in the *I_{CC3}* specification.

PAGE MODE

Page mode operation allows faster successive memory operations at multiple column locations of the same row address with increased speed.

This is done by strobing the row address into the chip and maintaining \overrightarrow{RAS} at a logic low throughout all successive \overrightarrow{CAS} memory cycles in which the row address is latched. As the time normally required for strobing a new row address is eliminated, access and cycle times can be descreaded and the operating power is reduced. These are specifications.

